

General Description

The LTP8M420X integrates dual linear voltage regulators, featuring high input voltage and low quiescent current (IQ), making it an optimal 300mA LDO solution for portable battery-powered applications requiring ultra-low standby current consumption. With an exceptionally low quiescent current of 5.3µA, it significantly extends battery life and enables reliable power supply for external device circuits.

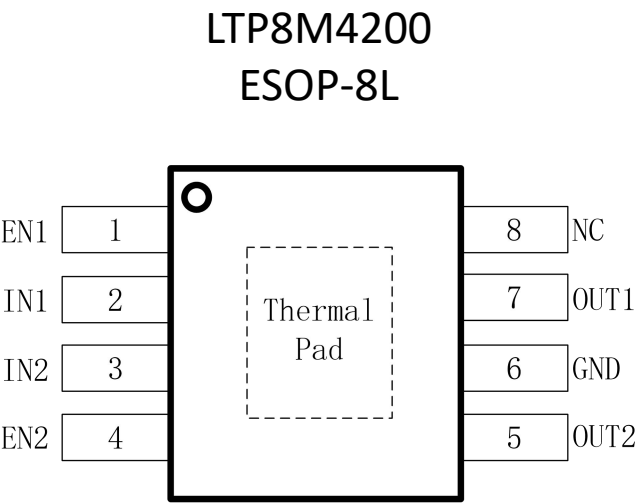
Features

- The wide input voltage range of 36V
- 3.3V & 12V regulated output with load capacity (LTP8M4200EXS8/R8)
- 5V& 12V regulated output with load capacity (LTP8M4201EXS8/R8)
- Ultra-low quiescent current IQ: 5.3uA
- Low Dropout: 1000mV @300mA
- The built-in over-temperature protection feature operates at a low pressure differential, with temperature thresholds set at 155°C.

Ordering Information

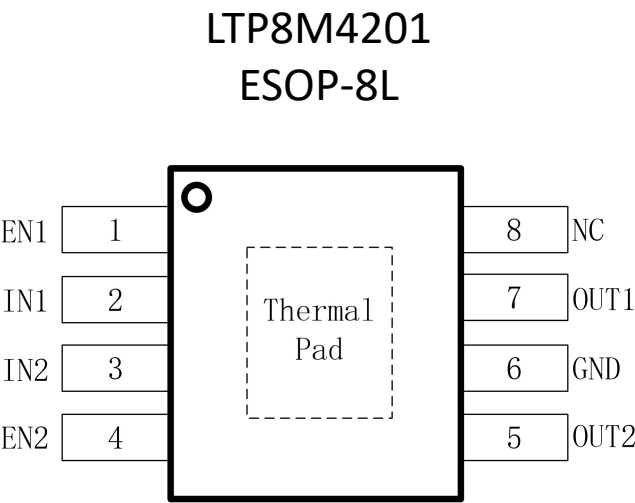
Type Number	Package Name	Tape and Reel	Mark Code	NOTE
LTP8M4200EXS8/R8	ESOP-8L	Tape and Reel, 4000	8M4200	OUT1 3.3V; OUT2 12V
LTP8M4201EXS8/R8	ESOP-8L	Tape and Reel, 4000	8M4201	OUT1 5.0V ;OUT2 12V

Pin Description (Top View)



Pin	Pin designation	Functional description
1	EN1	Enable 1 (Active High)
2	IN1	input1 pin
3	IN2	input2 pin
4	EN2	Enable 2 (Active High)
5	OUT2	Output2 pin (12V)
6	GND	Ground
7	OUT1	Output1 pin (3.3V)
8	NC	No connection
Thermal Pad		Must either be left open or tied to ground. — Solder to the printed-circuit-board (PCB) plane to enhance thermal performance.

Pin Description (Top View)



Pin	Pin designation	Functional description
1	EN1	Enable 1 (Active High)
2	IN1	input1 pin
3	IN2	input2 pin
4	EN2	Enable 2 (Active High)
5	OUT2	Output2 pin (12V)
6	GND	Ground
7	OUT1	Output1 pin (5.0V)
8	NC	No connection
Thermal Pad		Must either be left open or tied to ground. — Solder to the printed-circuit-board (PCB) plane to enhance thermal performance.

Absolute Maximum Ratings

T_A = 25°C, all pins are referenced to GND unless otherwise specified.
LTP8M4200EXS8/R8 (OUT1 :3.3V) LTP8M4201EXS8/R8(OUT1:5V)

Symbol	Rating	Value	Unit
IN1,IN2	Input Voltage	0~43	V
V _{OUT1}	Output Voltage	3.3	V
V _{OUT1}	Output Voltage	5	V
V _{OUT2}	Output Voltage	12	V
V _{EN}	Chip Enable Input	0~43	V
T _{J(MAX)}	Maximum Junction Temperature	150	°C
T _{STG}	Storage Temperature	-50~150	°C
J _A	Package Thermal Resistance	63	°C/W
ESD	HBM Capability	±1500	V
	CDM Capability	±2000	V

Recommended Operating Conditions

T_A = 25°C, all pins are referenced to GND unless otherwise specified.

Symbol	Item	Rating	Unit
IN1	Input Voltage	3 ~ 36	V
IN2	Input Voltage	3 ~ 36	V
I _{OUT1}	Output Current	0 ~ 300	mA
I _{OUT2}	Output Current	0 ~ 300	mA
T _A	Operating Ambient Temperature	-40 ~ 125	°C
C _{IN1}	Effective Input Ceramic Capacitor Value	1 ~ 10	uF
C _{IN2}	Effective Input Ceramic Capacitor Value	1 ~ 10	uF
C _{OUT1}	Effective Output Ceramic Capacitor Value	1 ~ 10	uF
C _{OUT2}	Effective Output Ceramic Capacitor Value	1 ~ 10	uF
ESR	Input and Output Capacitor Equivalent Series Resistance (ESR)	5 ~ 100	mΩ

Electrical Characteristic

LDO1 $V_{OUT}=3.3/5.0V$

($V_{IN}=V_{OUT}+2V$; $I_{OUT}=10mA$, $C_{IN}=C_{OUT}=1.0\mu F$, unless otherwise noted. Typical values are at $T_A=+25^\circ C$.)

Symbol	Parameter	Test Conditions	Min	Typ	Max	Unit
V_{IN}	Operating Input Voltage		3		36	V
V_{OUT}	Output Voltage	$T_A=+25^\circ C$	-2%		+2%	V
		$-40^\circ C \leq T_A \leq 85^\circ C$	-3%		+3%	
I_Q	Quiescent Current	$I_{OUT}=0mA$		2.5	4.5	μA
I_{Q_OFF}	Standby Current	$V_{EN}=0V, T_A=25^\circ C$		0.1	1	μA
$Line_{REG}$	Line Regulation	$V_{IN}=V_{OUT}+1V$ to 36V $I_{OUT}=10mA$ ($\Delta V_{OUT}/\Delta V_{IN}/V_{OUT}$)		0.05	0.20	%/V
V_{DROP}	Dropout Voltage $I_{OUT}=300mA$	$V_{OUT}=12V$		1000	1300	mV
$Load_{REG}$	Load Regulation	$1mA \leq I_{OUT} \leq 300mA$, $V_{IN}=V_{OUT}+3V$			40	mV
I_{LMT}	Current Limit	$V_{IN}=V_{OUT}+2V$	300	450		mA
V_{ENH}	EN Pin Threshold Voltage	EN Input Voltage "H"	1.2			V
V_{ENL}	EN Pin Threshold Voltage	EN Input Voltage "L"			0.4	V
I_{EN}	EN Pin Current	$V_{EN}=0 \sim 36V$		1		μA
PSRR	Power Supply Rejection Ratio	$f=1kHz$, $V_{IN}=V_{OUT}+1V$ $I_{OUT}=20mA$		60		dB
e_N	Output Noise Voltage	$V_{IN}=V_{OUT}+2V$, $I_{OUT}=1mA$ $f=10Hz$ to 100KHz $V_{OUT}=3V, C_{OUT}=1\mu F$		100		μV_{rms}
T_{SD}	Thermal Shutdown Temperature	Temperature Increasing from $T_A=+25^\circ C$		155		$^\circ C$
T_{SDH}	Thermal Shutdown Hysteresis	Temperature Falling from TSD		30		$^\circ C$

Electrical Characteristic (Cont.)

LDO2 $V_{OUT}=12V$ $(V_{IN}=V_{OUT}+2V; I_{OUT}=10mA, C_{IN}=C_{OUT}=1.0\mu F, \text{unless otherwise noted. Typical values are at } T_A=+25^\circ C.)$

Symbol	Parameter	Test Conditions	Min	Typ	Max	Unit
V_{IN}	Operating Input Voltage		3.0		36	V
V_{OUT}	Output Voltage	$T_A=+25^\circ C$	-2%		+2%	V
		$-40^\circ C \leq T_A \leq 85^\circ C$	-3%		+3%	V
I_Q	Quiescent Current	$I_{OUT}=0mA$		2.8	6.5	μA
I_{Q_OFF}	Standby Current	$V_{EN}=0V, T_A=25^\circ C$			1	μA
$Line_{REG}$	Line Regulation	$V_{IN}=V_{OUT}+1V \text{ to } 36V$ $I_{OUT}=10mA$ $(\Delta V_{OUT}/\Delta V_{IN}/V_{OUT})$		40	90	mV
V_{DROP}	DropOUT Voltage $I_{OUT}=300mA$	$V_{OUT}=3.3V$		1000	1500	mV
$Load_{REG}$	Load Regulation	$1mA \leq I_{OUT} \leq 300mA,$ $V_{IN}=V_{OUT}+3V$		90	180	mV
I_{LMT}	Current Limit	$V_{IN}=V_{OUT}+2V$		450	800	mA
I_{SHORT}	Short Current Limit	$V_{OUT}=0V$		55	120	mA
V_{ENH}	EN Pin Threshold Voltage	EN Input Voltage "H"	1.4			V
V_{ENL}	EN Pin Threshold Voltage	EN Input Voltage "L"			0.4	V
I_{EN}	EN Pin Current	$V_{EN}=0 \sim 36V$		1		μA
PSRR	Power Supply Rejection Ratio	$f=1kHz, V_{IN}=V_{OUT}+1V$ $I_{OUT}=20mA$		52		dB
e_N	Output Noise Voltage	$V_{IN}=V_{OUT}+2V, I_{OUT}=1mA$ $f=10Hz \text{ to } 100kHz$ $V_{OUT}=3V, C_{OUT}=1\mu F$		360		μV_{rms}
t_{ON}	Turn-On Time	From assertion of V_{EN} to $V_{OUT}=90\%V_{OUT(NOM)}$		1		ms
V_{TRLN}	Line transient	$V_{IN}=V_{OUT}+2V \text{ to } V_{OUT}+10V \text{ in } 10\mu s,$ $I_{OUT}=1mA, T_A=+25^\circ C$		50		mV
		$V_{IN}=V_{OUT}+10V \text{ to } V_{OUT}+2V \text{ in } 10\mu s,$ $I_{OUT}=1mA, T_A=+25^\circ C$		50		mV
V_{TRLD}	Load transient	$I_{OUT}=1mA \text{ to } 300mA \text{ in } 10\mu s$ $V_{IN}=V_{OUT}+2V, T_A=+25^\circ C$		210		mV
		$I_{OUT}=300mA \text{ to } 1mA \text{ in } 10\mu s$ $V_{IN}=V_{OUT}+2V, T_A=+25^\circ C$		160		mV
T_{SD}	Thermal Shutdown Temperature	Temperature Increasing from $T_A=+25^\circ C$		155		$^\circ C$
T_{SDH}	Thermal Shutdown Hysteresis	Temperature Falling from TSD		25		$^\circ C$

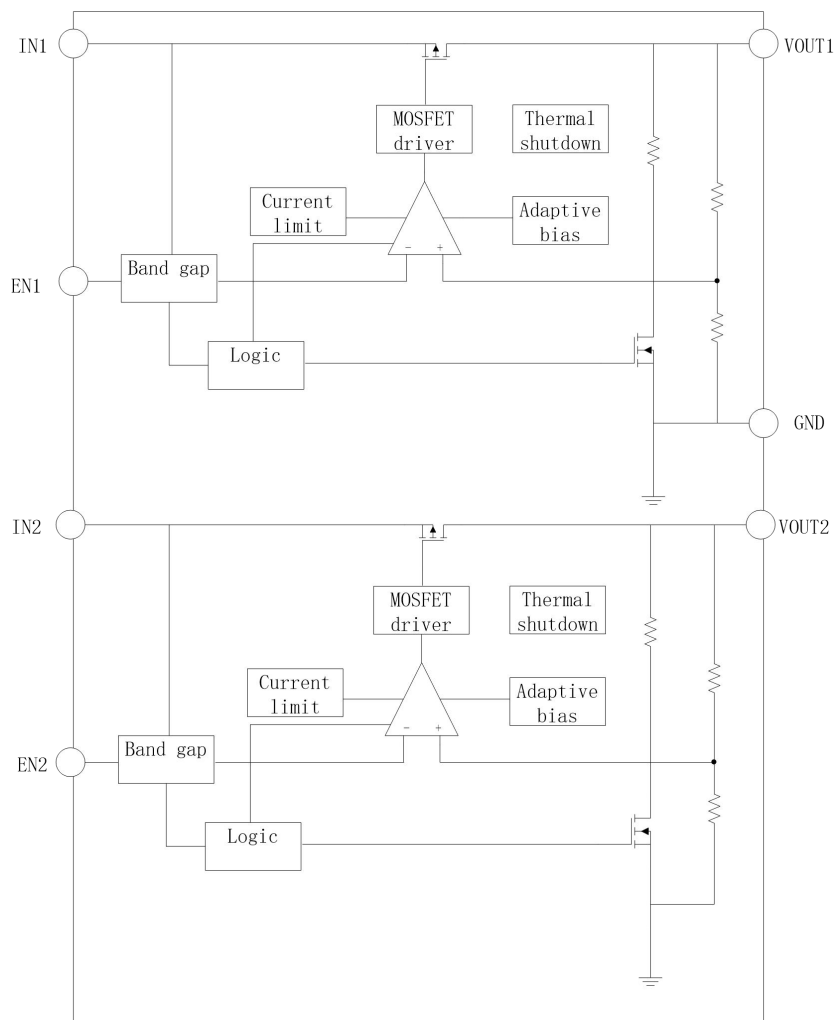
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Block Diagram



Functional Description

Input Capacitor

A $1\mu\text{F}$ ~ $10\mu\text{F}$ ceramic capacitor is recommended to connect between VIN and GND pins to decouple input power supply glitch and noise. The amount of the capacitance may be increased without limit. This input capacitor must be located as close as possible to the device to assure input stability and less noise. For PCB layout, a wide copper trace is required for both VIN and GND.

Output Capacitor

An output capacitor is required for the stability of the LDO. The recommended output capacitance is from $1\mu\text{F}$ to $10\mu\text{F}$, Equivalent Series Resistance (ESR) is from $5\text{m}\Omega$ to $100\text{m}\Omega$, and temperature characteristics are X7R or X5R. Higher capacitance values help to improve load/line transient response. The output capacitance may be increased to keep low undershoot/overshoot. Place output capacitor as close as possible to OUT and GND pins.

Block Diagram (Cont.)

Enable

The LTP8M420X delivers the output power when it is set to enable state. When it works in disable state, there is no output power and the operation quiescent current is almost zero. The enable pin (EN) is active high.

Dropout Voltage

The LTP8M420X uses a PMOS pass transistor to achieve low dropout. When $(V_{IN} - V_{OUT})$ is less than the dropout voltage (VDO), the PMOS pass device is in the linear region of operation and the input-to-output resistance is the $R_{DS(ON)}$ of the PMOS pass element. VDO scales approximately with output current because the PMOS device behaves like a resistor in dropout mode. As with any linear regulator, PSRR and transient response degrade as $(V_{IN} - V_{OUT})$ approaches dropout operation.

Thermal Shutdown

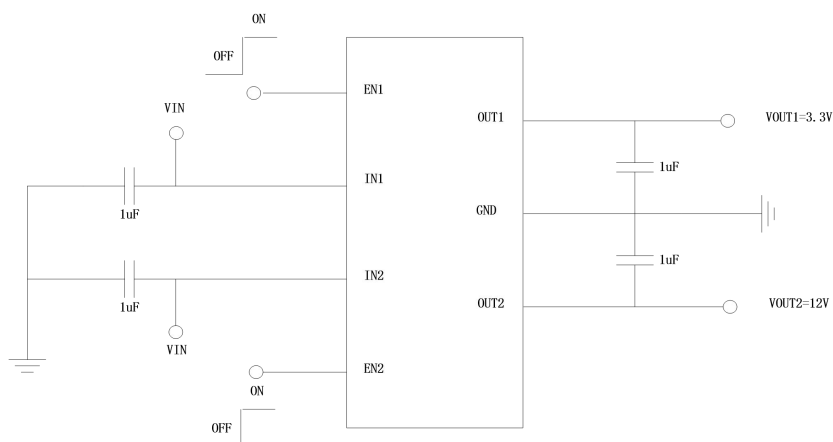
Thermal shutdown protection disables the output when the junction temperature rises to approximately 155°C. Disabling the device eliminates the power dissipated by the device, allowing the device to cool. When the junction temperature cools to approximately 125°C, the output circuitry is again enabled.

Depending on power dissipation, thermal resistance, and ambient temperature, the thermal protection circuit may cycle on and off. This cycling limits regulator dissipation, protecting the LDO from damage as a result of overheating. Activating the thermal shutdown feature usually indicates excessive power dissipation as a result of the product of the $(V_{IN} - V_{OUT})$ voltage and the load current. For reliable operation, limit junction temperature to 125°C maximum.

Current-Limit Protection

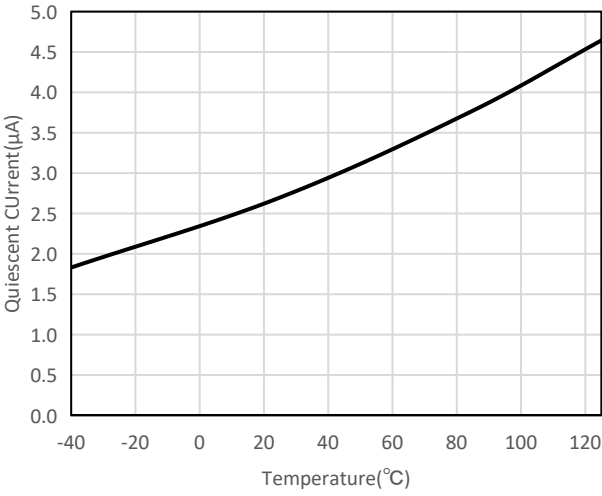
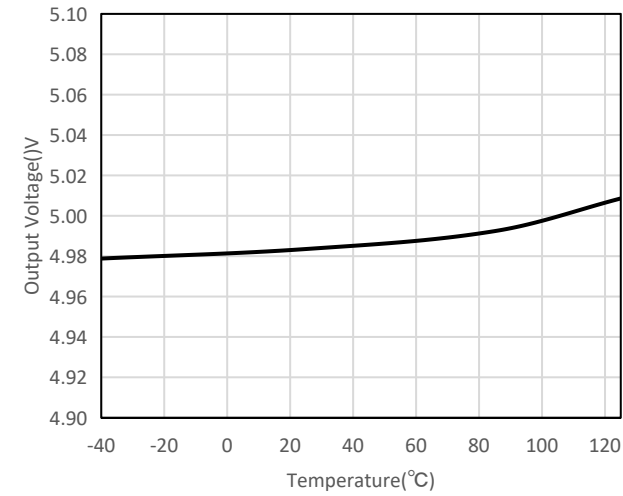
The LTP8M420X provides current limit function to prevent the device from damages during over-load or shorted-circuit condition. This current is detected by an internal sensing transistor.

Application Circuits

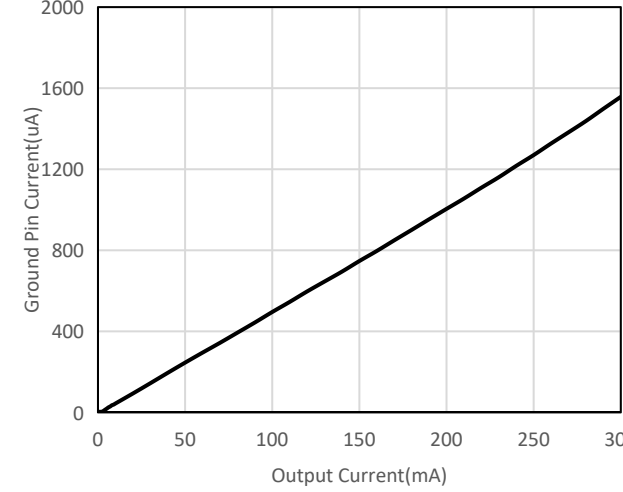


Typical Characteristics

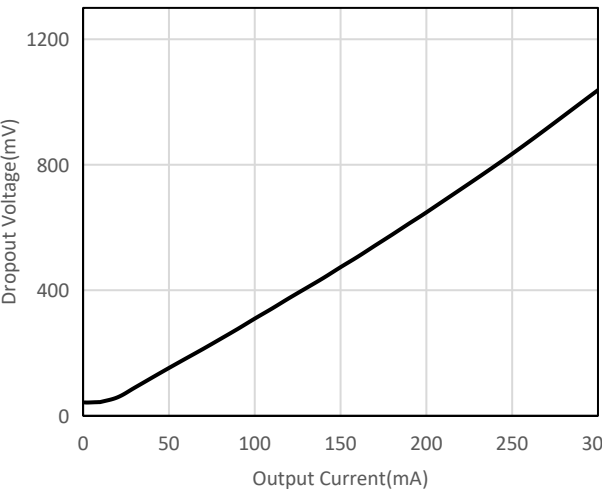
LDO1 (5.0V)



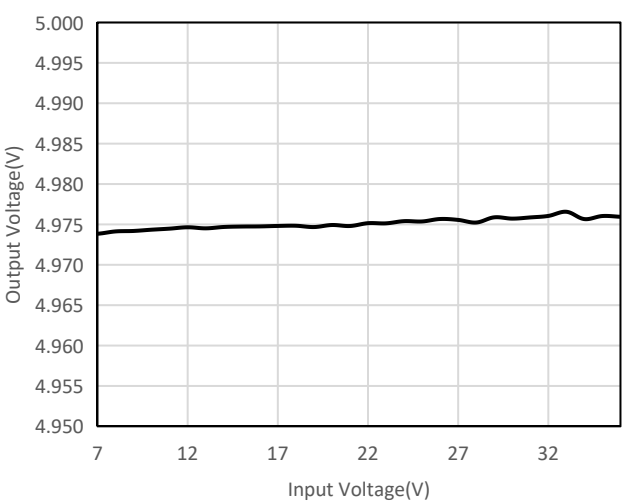
Output Voltage VS Temperature



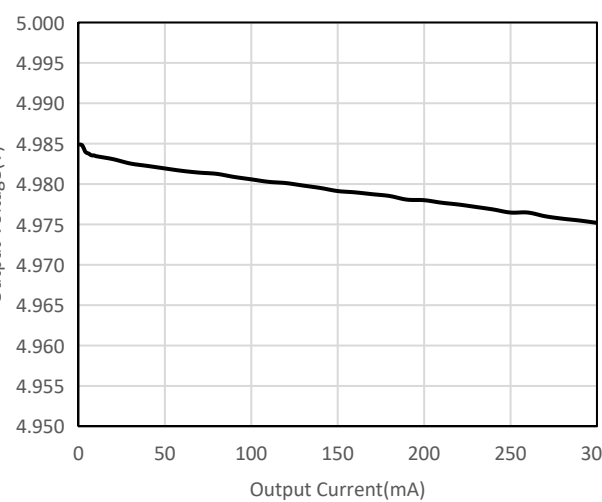
Quiescent Current VS Temperature



Ground Pin Current VS Output Current



Dropout Voltage VS Output Current



Output Voltage VS Input Voltage

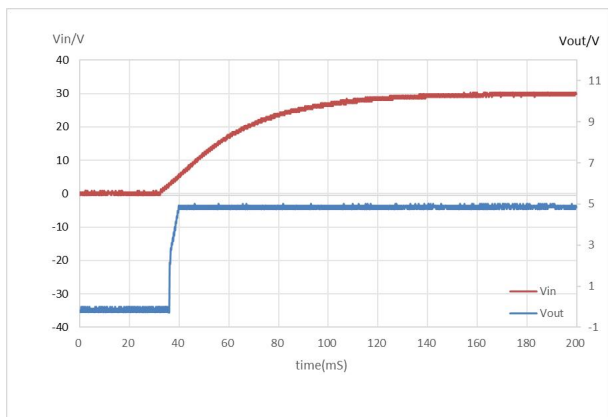
Output Voltage VS Output Current

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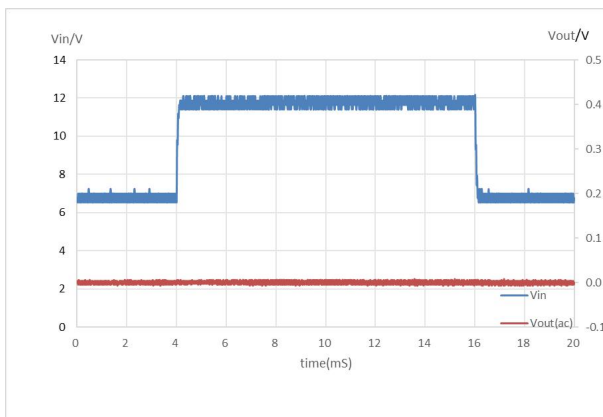


Typical Characteristics (Cont.)

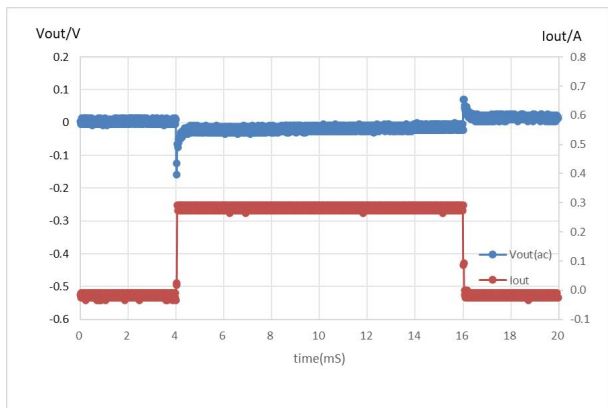
LDO1 (5.0V)



Start-up Response



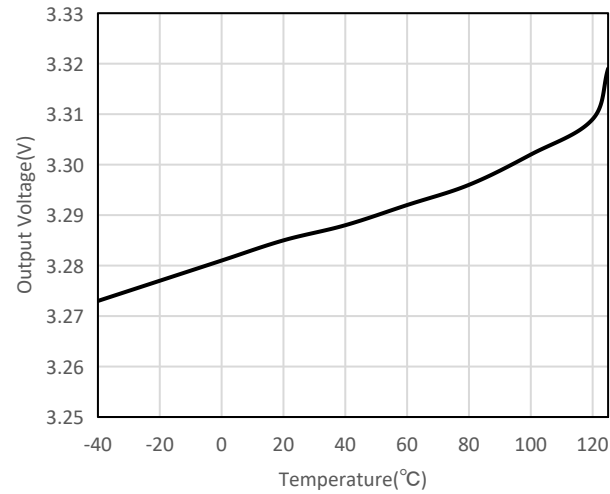
Line-Transient Response



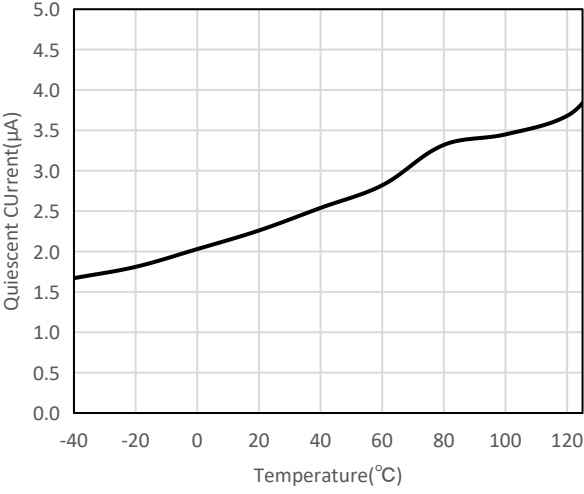
Load-Transient Response

Typical Characteristics (Cont.)

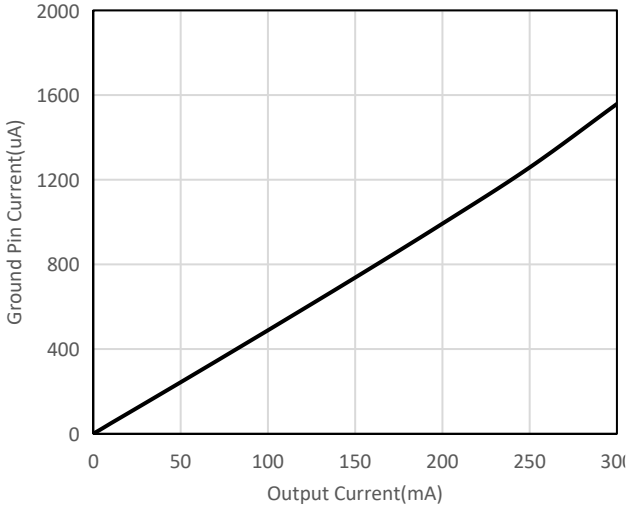
LDO1 (3.3V)



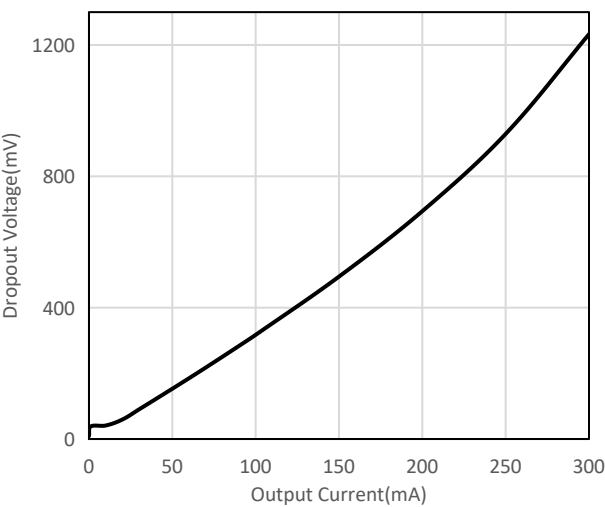
Output Voltage VS Temperature



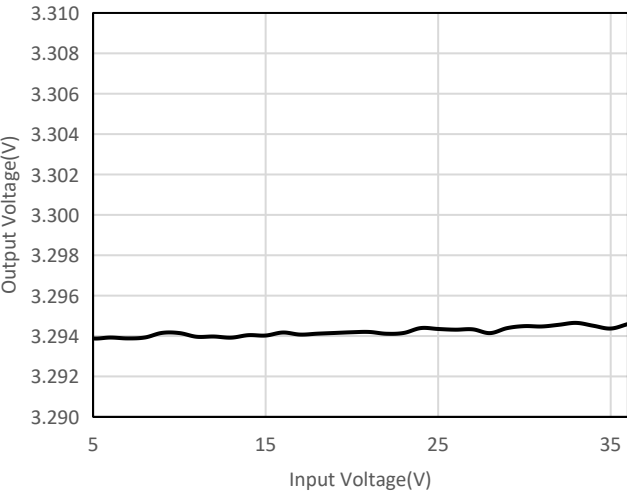
Quiescent Current VS Temperature



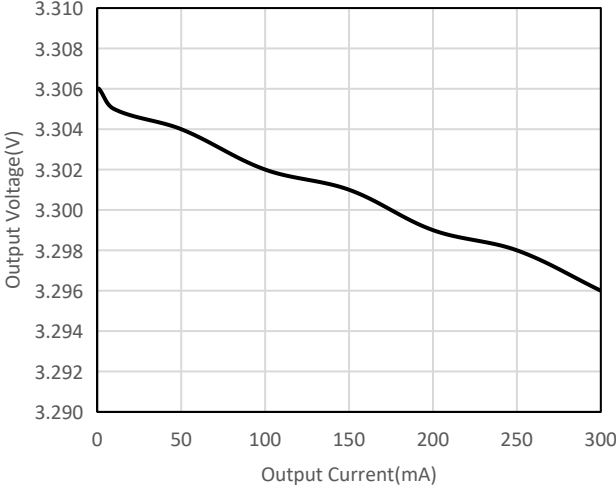
Ground Pin Current VS Output Current



Dropout Voltage VS Output Current



Output Voltage VS Input Voltage



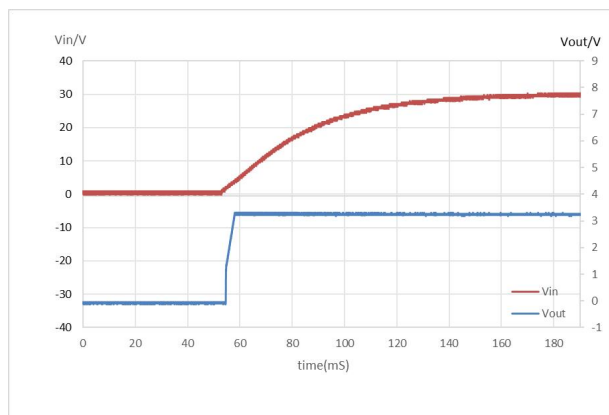
Output Voltage VS Output Current

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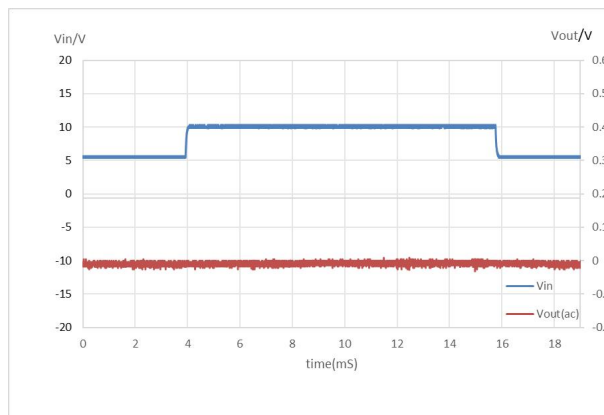


Typical Characteristics (Cont.)

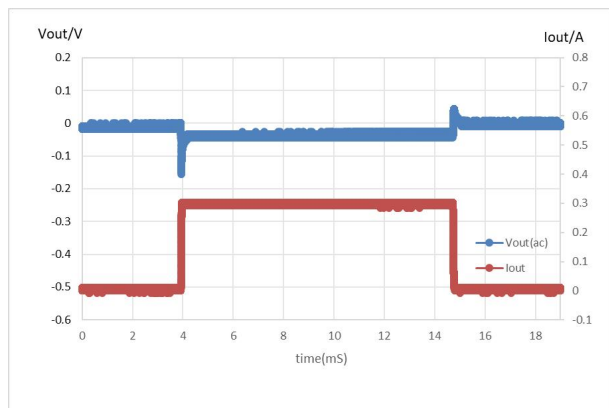
LDO1 (3.3V)



Start-up Response



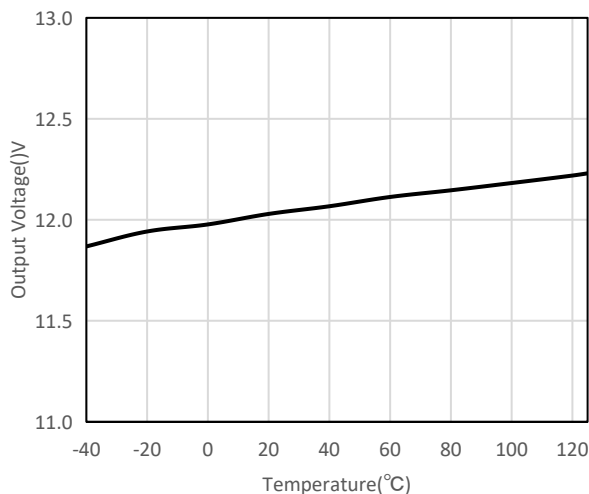
Line-Transient Response



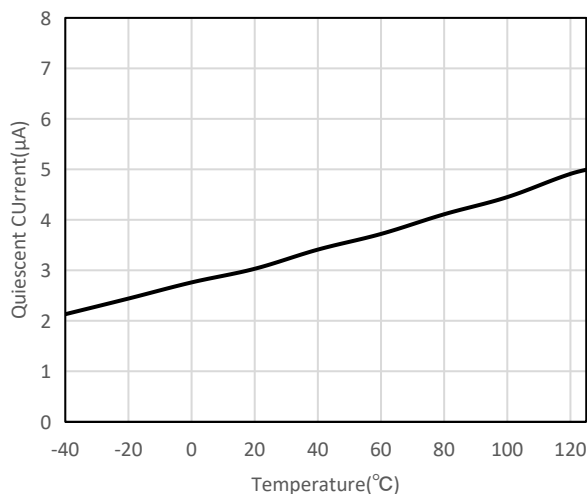
Load-Transient Response

Typical Characteristics (Cont.)

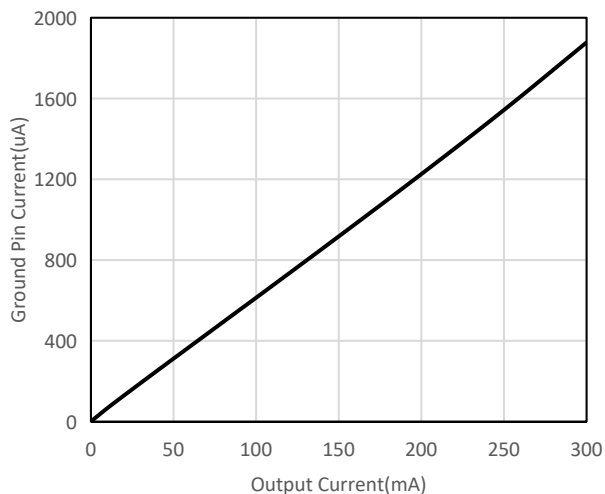
LDO2 (12V)



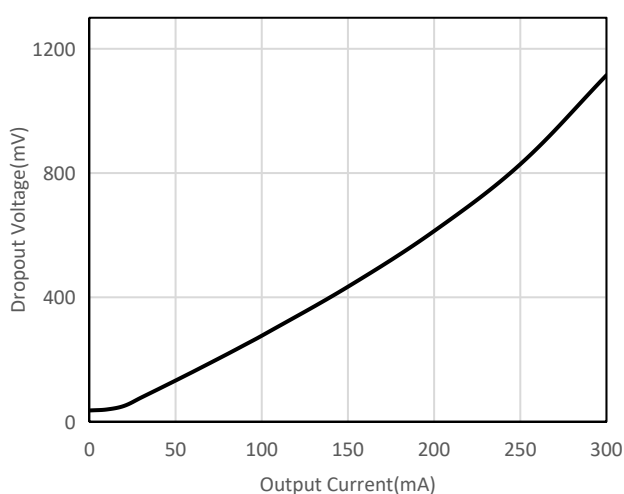
Output Voltage VS Temperature



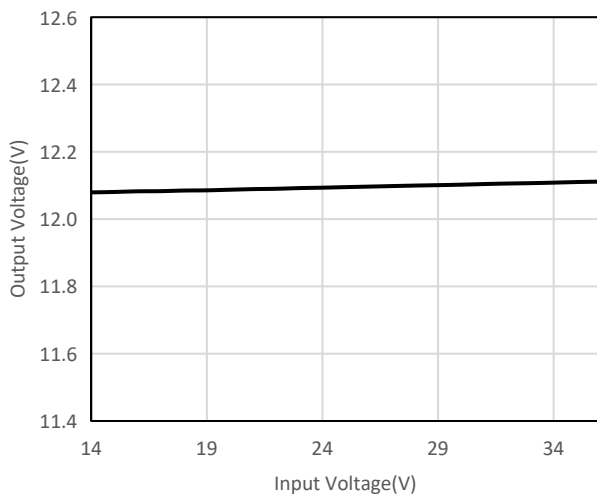
Quiescent Current VS Temperature



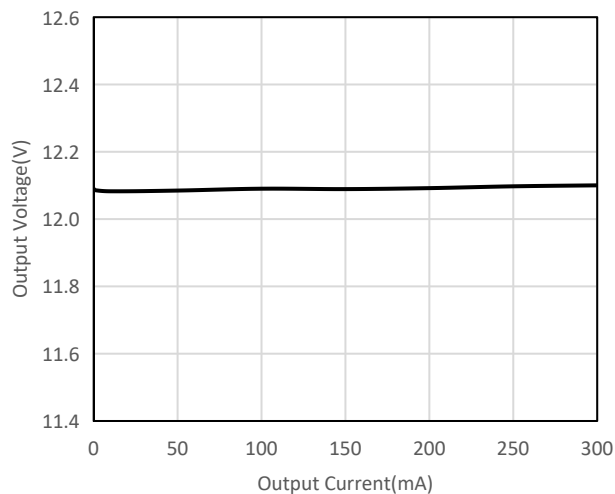
Ground Pin Current VS Output Current



Dropout Voltage VS Output Current



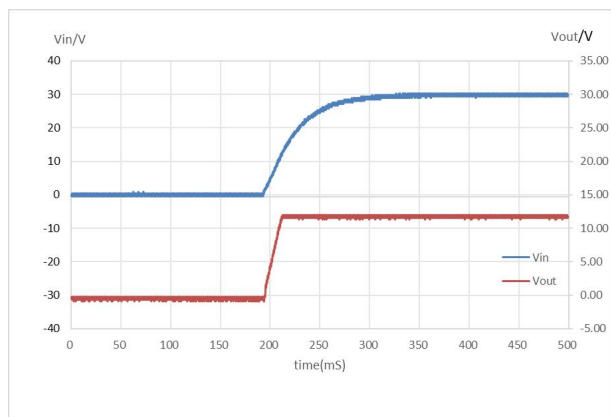
Output Voltage VS Input Voltage



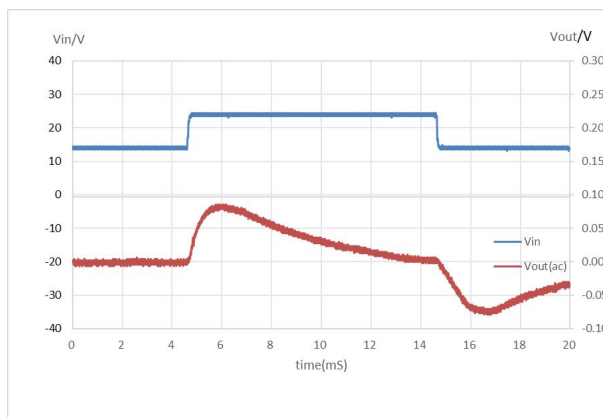
Output Voltage VS Output Current

Typical Characteristics (Cont.)

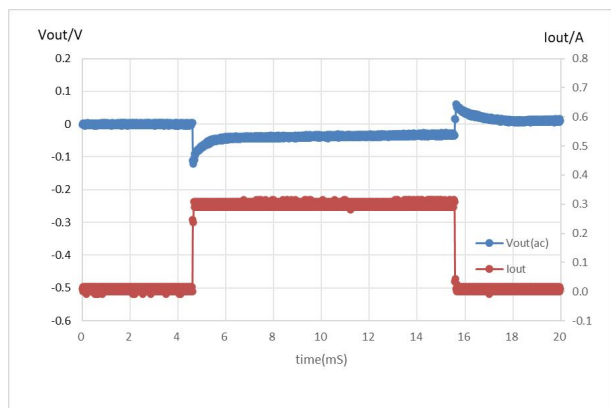
LDO2 (12V)



Start-up Response

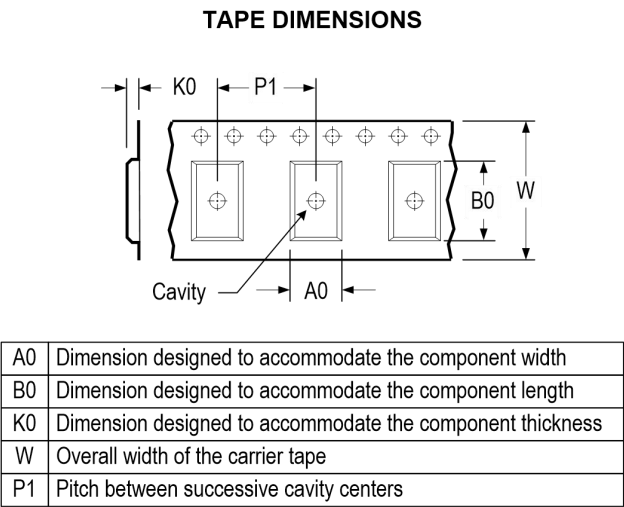
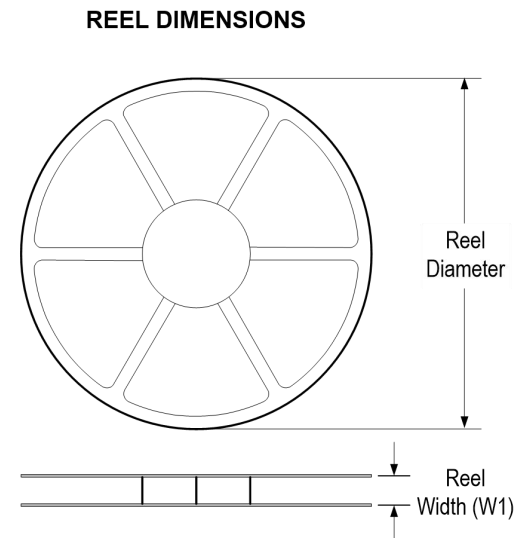


Line-Transient Response

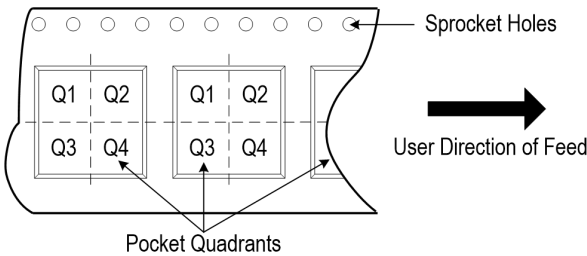


Load-Transient Response

Tape and Reel Information



QUADRANT ASSIGNMENTS FOR PIN 1 ORIENTATION IN TAPE

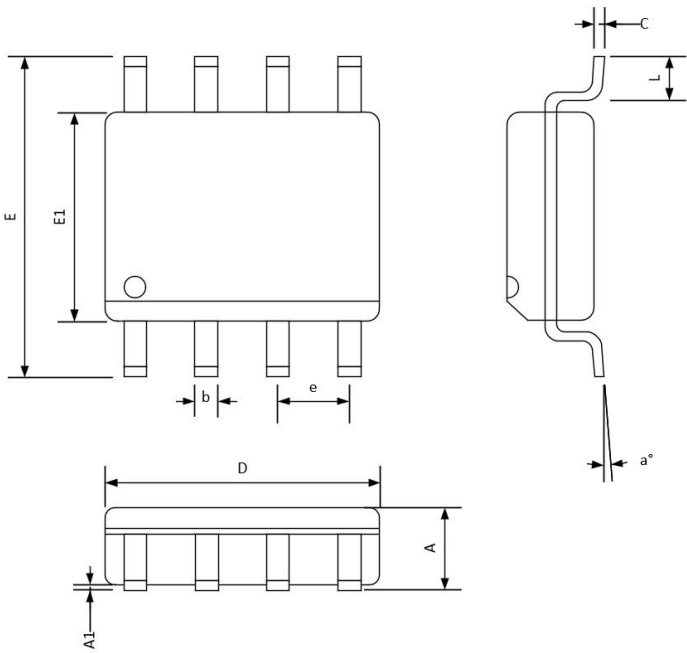


* All dimensions are nominal

Device	Package Type	Pins	SPQ	Reel Diameter (mm)	Reel Width W1 (mm)	A0 (mm)	B0 (mm)	K0 (mm)	P1 (mm)	W (mm)	Pin 1 Quadrant
LTP8M4200EXS8/R8	ESOP	8	4 000	330	12.5	6.6	5.3	2.0	8.0	12.0	Q1
LTP8M4201EXS8/R8	ESOP	8	4 000	330	12.5	6.6	5.3	2.0	8.0	12.0	Q1

Package Dimension

ESOP-8L



SYMBOL	MILLIMETER		
	MIN	NOM	MAX
A	--	--	1.75
A1	0.10	--	0.23
b	0.33	--	0.53
c	0.17	--	0.25
D	4.70	4.90	5.10
E	5.80	6.00	6.20
E1	3.70	3.90	4.10
e	1.27BSC		
L	0.50	--	0.80
a°	0°	--	8°

Important Notice

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